June 12-15, 2018
Sumy, Ukraine

Together we can do more for science, technology, engineering and education
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DSM:IE 2018

International Conference on **Design, Simulation, Manufacturing: The Innovation Exchange**

http://dsmie.sumdu.edu.ua

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About DSMIE-2018

DSMIE-2018 is the international forum for fundamental and applied research and industrial applications in manufacturing.

International Conference on Design, Simulation, Manufacturing: The Innovation Exchange focuses on a broad range of research challenges in the fields of Manufacturing, Mechanical and Chemical Engineering, addressing current and future trends in design approaches, simulation techniques, computer-aided systems, software development, ICT tools and Industry 4.0 strategy implementation for engineering tasks solving. DSMIE-2018 brings together researchers from academic institutions, leading industrial companies, and government laboratories located around the world for promoting and popularization of the scientific fundamentals of manufacturing. The conference schedule will include keynote sessions and technical sessions, expert panels, an exhibition of industry partners and more.

The working language of the conference (including conference proceedings, presentations, and discussions) is **English**.

Organizer

Sumy State University,
Faculty of Technical Systems and Energy Efficient Technologies
(Sumy, Ukraine)

The Conference is organized under the patronage of **Prof. Anatoliy Vasylyev**, Rector of Sumy State University and **Dr. Oleksandr Gusak**, Dean of Faculty of Technical Systems and Energy Efficient Technologies.

Partners

Technical University of Kosice,
Faculty of Manufacturing Technologies with a seat in Presov
(Presov, Slovak Republic)

Kielce University of Technology,
Faculty of Management and Computer Modeling
(Kielce, Poland)

University of West Bohemia,
Faculty of Mechanical Engineering
(Plzen, Czech Republic)

Association for Promoting Innovative Technologies – InnovativeFET
(Zagreb, Croatia)

Springer,
Lecture Notes in Mechanical Engineering

EasyChair

Unicheck

Extended versions of best papers, presented at DSMIE-2018, will be considered for special issues of selected journals, subject to further review.

Management and Production Engineering Review (Poland)
ISSN 2080-8208, e-ISSN 2082-1344

Archives of Mechanical Technology and Materials (Poland)
ISSN 2450-9469

Journal of Engineering Sciences (Ukraine)
ISSN 2312-2498, e-ISSN 2414-9381

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Conference Topics

Manufacturing Engineering

- CAD/CAE Systems for Design of Products, Metalworking Equipment, Fixtures, Cutting Tools
- CAPP/CAM/CAQ Systems for Advanced Manufacturing and Assembling Technologies
- CAx Technologies for Manufacturing Engineering
- Information Management Systems for Manufacturing Enterprises
- Intelligent Manufacturing Systems
- Flexible Manufacturing Systems, Automation and Robotics
- Methods and Technologies for Additive Manufacturing
- Numerical Simulation in Materials Science
- Smart Manufacturing and Industry 4.0 Strategy
- ICT for Engineering Education

Mechanical Engineering

- Engineering Design and Optimization Using CAD/CAE Software
- Using CAE Software in Mechanics of Solids, Structures and Fluids
- Computer Modeling of Fracture, Failure and Fatigue
- Computational Techniques in Machine Mechanics and Dynamics
- Numerical Methods for Dynamics, Acoustics and Vibration
- Computational Methods for Control Theory
- Numerical Simulation of Nonlinear Dynamic Systems
- Simulation Software for Modeling Fluid-Structure Interaction
- Multiphysics Analysis of Coupled Systems

Chemical Engineering

- Theoretical Fundamentals and Mathematical Modeling of Chemical Process Technology
- Computational Fluid Dynamics, Thermodynamics, Heat and Mass Transfer
- Numerical Simulation and Optimization of Industrial Chemical Processes
- CAD/CAM/CAE Systems for Chemical Engineering and Plant Design
- SCADA Process Control Systems for the Chemical Industry
- Resource-Saving and Energy Efficient Technologies, Conversion and Utilization
- Alternative and Renewable Energy, Generation and Recovery
- Biotechnologies and Bioengineering, Bio-based Fuels, Food Technologies
- Industrial Ecology, Sustainable Engineering and Ecological Design

Agenda

June 12, 2018 – Tuesday	
8^{00}–14^{00}	Registration
14^{00}–15^{00}	University Tour
15^{00}–17^{00}	City Tour

June 13, 2018 – Wednesday	
8^{00}–9^{00}	Registration
9^{00}–9^{30}	Opening, Welcome & Message from the Conference Chairs
9^{30}–11^{00}	Keynote Session 1: Scientific aspect
11^{00}–11^{10}	Photo Session
11^{10}–11^{30}	Coffee Break
11^{30}–13^{00}	Keynote Session 2: Industrial aspect
13^{00}–14^{00}	Lunch
14^{00}–15^{30}	Conference Session 1
15^{30}–16^{00}	Coffee Break
16^{00}–17^{30}	Conference Session 2
17^{30}–18^{30}	Exhibition – Ideas Exchange (Discussion)
19^{00}–20^{00}	DSMIE-2018 Welcome Dinner

June 14, 2018 – Thursday	
9^{00}–9^{30}	Registration
9^{30}–11^{00}	Conference Session 3
11^{00}–11^{30}	Coffee Break
11^{30}–13^{00}	Conference Session 4
13^{00}–14^{00}	Lunch
14^{00}–15^{30}	Conference Session 5
15^{30} – 18^{00}	Industry Tour
18^{00}–20^{00}	Free Time – City Tour

June 15, 2018 – Friday	
9^{00}–9^{30}	Registration
9^{30}–11^{00}	Conference Session 6
11^{00}–11^{30}	Coffee Break
11^{30}–13^{00}	Conference Session 7
13^{00}–14^{00}	Lunch
14^{00}–15^{30}	Conference Session 8
15^{30} – 16^{00}	Awards and Farewell

Invitation to Sponsors

Become a Sponsor of **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange**, and expose your organization, company, product or service to hundreds of people interested in Manufacturing, Mechanical and Chemical Engineering.

On behalf of the DSMIE-2018 Team, we invite you to consider becoming a sponsor. We have a convenient Invitation to Sponsor that lists all the benefits of sponsoring DSMIE-2018. The brochure summarizes the different sponsorship packages.

DSMIE-2018 attracts the top researchers and practitioners of advanced engineering using computer-aided software, systems and equipment, as well as ICT tools for engineering. This year we expect around 100 participants with a mix from universities and industry from Belarus, Bulgaria, Czech Republic, Moldova, Poland, Romania, Russian Federation, Serbia, Slovak Republic, Ukraine, and others.

Therefore, as a sponsor of DSMIE-2018, your organization will have a unique opportunity to interact with the leading researchers, students and practitioners of advanced engineering techniques.

Please do not hesitate to contact us for more information on the sponsorship plan.

If you are interested in sponsoring this event, please write an email to **dsmie@teset.sumdu.edu.ua**. In your request please indicate:

- the sponsorship level you are interested in (see below);
- an overview of what you wish to promote at the conference (e.g. tool, service, product, book etc.).

We look forward to your generous support to make DSMIE-2018 a great success!

Join us as a Sponsor of DSMIE-2018

Sponsorship Packages

We offer You one of four major sponsorship packages. Join us as a Sponsor of the DSMIE-2018 and you can have the chance to share your ***professional activities, products and services*** among the conference participants, partners and sponsors, and DSMIE community

Main Sponsor

Platinum Sponsor

Gold Sponsor

Silver Sponsor

In addition to the four packages of sponsorship You may also find other opportunities to lend further support to DSMIE-2018's worthwhile activities.

Media Sponsor

- you can help us to share the ***information*** about the event before and after the conference dates

Social Sponsor

- you can help us to organize the ***social activities*** within the conference

Giveaway Sponsor

- you can help us to provide an ***unforgettable memories*** about the conference

Best Presentation Award Sponsor

- you can help us to ***congratulate 3 best presentations***

Break Sponsor

- you can help us to organize the ***friendly discussion*** during the coffee breaks

Transport Sponsor

- you can help us to organize the **transport services** during the conference dates

Sponsorship Packages

Benefit
Promotion during the conference
Exhibition space in the lobby of Conference Centre equipped with tables and chairs (different conditions for different sponsorship packages)
Placement of sponsor's logo on the Main Conference Banner (different sizes for different sponsorship packages)
Sponsor's banner at the Opening Ceremony, Keynote Sessions, and Awards & Farewell Session (size 0,8x2,0 m) – during 3 days
Sponsor's banner at the Technical Sessions (size 0,8x2,0 m) – during 3 days
5 minutes' speech at the Opening Ceremony of the conference
30 minutes' lecture at the Keynote Session of the conference
15 minutes' lecture at the Technical Session of the conference
Free registration for the conference (conference bag, participation in conference sessions, coffee breaks, social events, DSMIE-2018 Welcome Dinner)
5 minutes' speech at the DSMIE-2018 Welcome Dinner
Promotion in conference promotional materials
Placement of sponsor's logo on the Conference Website with a link to a webpage
Placement of sponsor's logo on the Conference Facebook fanpage with a link to a webpage
Placement of sponsor's logo in the official informational leaflets of the conference
Placement of sponsor's logo in informational leaflets published by Media Sponsors
Placement of sponsor's logo in conference program
Placement of sponsor's logo in conference presentations of participants
Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors
Brief information about the sponsor in conference program with a volume of max. pages (A5 format)
Promotion in Conference materials
Placement of sponsor's logo on materials for participants (conference bag, notepad) to be given to all participants of the conference (different sizes for different sponsorship packages)
Placement of sponsor's logo on participant ID
Placement of sponsor's logo on Official Conference Photo
Placement of sponsor's logo on Certificate of Participation
Putting in conference bags the promotional materials of the sponsor
Thank you letter after the conference to all participants with the information about sponsors
Availability of packages

Join us as a Sponsor of DSMIE-2018

Sponsorship Packages

Sponsorship packages			
Main	**Platinum**	**Gold**	**Silver**
20000 UAH (1000 EUR)	15000 UAH (750 EUR)	7500 UAH (375 EUR)	5000 UAH (250 EUR)
Promotion during the conference			
☑	☑	⊘	⊘
☑	☑	☑	☑
☑	⊘	⊘	⊘
☑	☑	⊘	⊘
☑	⊘	⊘	⊘
☑	⊘	⊘	⊘
⊘	☑	⊘	⊘
3	**2**	**1**	**1**
☑	⊘	⊘	⊘
Promotion in conference promotional materials			
☑	☑	☑	☑
☑	☑	☑	☑
☑	☑	☑	☑
☑	⊘	⊘	⊘
☑	☑	☑	☑
☑	⊘	⊘	⊘
☑	☑	☑	☑
2	**1**	**0,5**	⊘
Promotion in Conference materials			
☑	☑	☑	⊘
☑	⊘	⊘	⊘
☑	⊘	⊘	⊘
☑	☑	⊘	⊘
☑	☑	☑	☑
☑	☑	⊘	⊘
1	**4–6**	**6–8**	**8–12**

Main Sponsor

Contribution: 20000 UAH (1000 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

The most exclusive package consists of:

1. Promotion during the conference

1.1. Exhibition space in the lobby of Conference Centre (equipped with a tables and chairs)
1.2. Placement of sponsor's logo on the Main Conference Banner (the largest size of logo)
1.3. Sponsor's banner at the Opening Ceremony, Keynote Sessions, Technical Sessions, and Awards & Farewell Session (size 0,8x2,0 m) – during 3 days
1.4. 5 minutes' speech at the Opening Ceremony of the conference
1.5. 30 minutes' lecture at the Keynote Session of the conference
1.6. Free registration for the conference for 3 persons delegated by the sponsor (conference bag, participation in conference sessions, coffee breaks, social events, DSMIE-2018 Welcome Dinner)
1.7. 5 minutes' speech at the DSMIE-2018 Welcome Dinner

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Main Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Main Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo as Main Sponsor in the official informational leaflets of the conference
2.4. Placement of sponsor's logo as Main Sponsor in informational leaflets published by Media Sponsors
2.5. Placement of sponsor's logo as Main Sponsor in conference program
2.6. Placement of sponsor's logo in conference presentations of participants
2.7. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors
2.8. Brief information about the sponsor in conference program with a volume of max. 2 pages (A5 format)

3. Promotion in Conference materials

3.1. Placement of sponsor's logo on materials for participants (conference bag, notepad) to be given to all participants of the conference (the largest size of logo)
3.2. Placement of sponsor's logo on participant ID
3.3. Placement of sponsor's logo on Official Conference Photo
3.4. Placement of sponsor's logo on Certificate of Participation
3.5. Putting in conference bags the promotional materials of the sponsor
3.6. Thank you letter after the conference to all participants with the information about sponsors

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

DSM:IE 2018

Platinum Sponsor

Contribution: 15000 UAH (750 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

The platinum package consists of:

1. Promotion during the conference

1.1. Exhibition space in the lobby of Conference Centre (equipped with a tables and chairs)
1.2. Placement of sponsor's logo on the Main Conference Banner (the second largest size of logo)
1.3. Sponsor's banner at the Technical Sessions (size 0,8x2,0 m) – during 3 days
1.4. 15 minutes' lecture at the Technical Session of the conference
1.5. Free registration for the conference for 2 persons delegated by the sponsor (conference bag, participation in conference sessions, coffee breaks, social events, DSMIE-2018 Welcome Dinner)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Platinum Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Platinum Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo as Platinum Sponsor in the official informational leaflets of the conference
2.4. Placement of sponsor's logo as Platinum Sponsor in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors
2.6. Brief information about the sponsor in conference program with a volume of max. 1 page (A5 format)

3. Promotion in Conference materials

3.1. Placement of sponsor's logo on materials for participants (conference bag, notepad) to be given to all participants of the conference (the second largest size of logo)
3.2. Placement of sponsor's logo on Certificate of Participation
3.3. Putting in conference bags the promotional materials of the sponsor
3.4. Thank you letter after the conference to all participants with the information about sponsors

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

Gold Sponsor

Contribution: 7500 UAH (375 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

The gold package consists of:

1. Promotion during the conference

1.1. Placement of sponsor's logo on the Main Conference Banner (the third largest size of logo)
1.2. Free registration for the conference for 1 person delegated by the sponsor (conference bag, participation in conference sessions, coffee breaks, social events, DSMIE-2018 Welcome Dinner)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Gold Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Gold Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo as Gold Sponsor in the official informational leaflets of the conference
2.4. Placement of sponsor's logo as Gold Sponsor in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors
2.6. Brief information about the sponsor in conference program with a volume of max. 0,5 page (A5 format)

3. Promotion in Conference materials

3.1. Placement of sponsor's logo on materials for participants (conference bag, notepad) to be given to all participants of the conference (the third largest size of logo)
3.2. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

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Silver Sponsor

Contribution: 5000 UAH (250 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

The silver package consists of:

1. Promotion during the conference

1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)
1.2. Free registration for the conference for 1 person delegated by the sponsor (conference bag, participation in conference sessions, coffee breaks, social events, DSMIE-2018 Welcome Dinner)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Silver Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Silver Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo as Silver Sponsor in the official informational leaflets of the conference
2.4. Placement of sponsor's logo as Silver Sponsor in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors

3. Promotion in Conference materials

3.1. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

Media Sponsor

Contribution: 0 UAH (0 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

In this package the contribution is 0 UAH (0 EUR), but we ask you to help us to share information to wide auditory about DSMIE-2018 in your printing and electronic resources. **Your help will be in:**

- Placement of DSMIE-2018's logo and briefing about the conference on the Media Sponsor's Website with a link to a webpage http://dsmie.sumdu.edu.ua/;
- Placement of DSMIE-2018's logo on the Media Sponsor's Facebook fanpage (if available) with a link to a webpage http://dsmie.sumdu.edu.ua/;
- Publishing 4 informational leaflets of the DSMIE-2018 designed by DSMIE team in your printing and electronic resources.

The media sponsor package consists of:

1. Promotion during the conference

1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Media Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Media Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo as Media Sponsor in the official informational leaflets of the conference
2.4. Placement of sponsor's logo as Media Sponsor in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors

3. Promotion in Conference materials

3.1. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

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Social Sponsor

Contribution: 0 UAH (0 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

In this package the contribution is 0 UAH (0 EUR), but we ask you to help us to organize social activities for conference participants. **Your help will be in:**

- City Tour (June 12, 2018);
- Printed materials about touristic attractions in Sumy;
- Printed map of Sumy city.

The social sponsor package consists of:

1. Promotion during the conference

1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Social Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Social Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo in the official informational leaflets of the conference
2.4. Placement of sponsor's logo in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors

3. Promotion in Conference materials

3.1. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

DSMIE 2018

Giveaway Sponsor

Contribution: 5000 UAH (250 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

The giveaway sponsor package consists of:

1. **Promotion during the conference**
   - 1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)
2. **Promotion in conference promotional materials**
   - 2.1. Placement of sponsor's logo as Giveaway Sponsor on the Conference Website with a link to a webpage
   - 2.2. Placement of sponsor's logo as Giveaway Sponsor on the Conference Facebook fanpage with a link to a webpage
   - 2.3. Placement of sponsor's logo in the official informational leaflets of the conference
   - 2.4. Placement of sponsor's logo in conference program
   - 2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors
3. **Promotion in Conference materials**
   - 3.1. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

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Best Presentation Award Sponsor

Contribution: 10000 UAH (500 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

This sponsor package aimed to acknowledge three best presentations (one presentation in each conference topic). The Certificate of Award will be given by person delegated by the sponsor at Awards & Farewell Session (June 15, 2018).

The best presentation award sponsor package consists of:

1. **Promotion during the conference**
   - 1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)
2. **Promotion in conference promotional materials**
   - 2.1. Placement of sponsor's logo as Best Presentation Award Sponsor on the Conference Website with a link to a webpage
   - 2.2. Placement of sponsor's logo as Best Presentation Award Sponsor on the Conference Facebook fanpage with a link to a webpage
   - 2.3. Placement of sponsor's logo as Best Presentation Award Sponsor in the official informational leaflets of the conference
   - 2.4. Placement of sponsor's logo as Best Presentation Award Sponsor in conference program
   - 2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors
3. **Promotion in Conference materials**
   - 3.1. Placement of sponsor's logo on Certificate of Award
   - 3.2. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

DSMIE 2018

Break Sponsor

Contribution: 2000 UAH (100 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

The break sponsor package (calculated for one coffee break session) consists of:

1. Promotion during the conference

1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Break Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Break Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo in the official informational leaflets of the conference
2.4. Placement of sponsor's logo in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors

3. Promotion in Conference materials

3.1. Putting in conference bags the promotional materials of the sponsor
3.2. Distribution of your promotional materials (provided by sponsor) during coffee break session

Also, it's possible to place the sponsor's banner at the coffee break session at extra charge option.
For your request, we can suggest a single package for all coffee break sessions.

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

DSMIE 2018

Transport Sponsor

Contribution: 0 UAH (0 EUR)

You are invited to support the **International Conference on Design, Simulation, Manufacturing: The Innovation Exchange (DSMIE-2018)**, organized by Sumy State University.

This is an ideal way to demonstrate your organization's commitment to the fields of Manufacturing, Mechanical and Chemical Engineering, and interdisciplinary researches at the frontier of technological innovation – and to publicize this support to many leaders in the field.

In this package the contribution is 0 UAH (0 EUR), but we ask you to help us to organize transport services during the conference dates. **Your help will be in:**

- Transport services during City Tour (June 12, 2018) – approx. 3 hours;
- Transfer from Conference venue to Welcome Dinner venue (June 13, 2018) – approx. 1 hour;
- Transport services during Industry Tour (June 14, 2018) – approx. 4 hours.

The transport sponsor package consists of:

1. Promotion during the conference

1.1. Placement of sponsor's logo on the Main Conference Banner (the smallest size of logo)

2. Promotion in conference promotional materials

2.1. Placement of sponsor's logo as Social Sponsor on the Conference Website with a link to a webpage
2.2. Placement of sponsor's logo as Social Sponsor on the Conference Facebook fanpage with a link to a webpage
2.3. Placement of sponsor's logo in the official informational leaflets of the conference
2.4. Placement of sponsor's logo in conference program
2.5. Brief information about the sponsor on the conference website in the section Sponsorship/Sponsors

3. Promotion in Conference materials

3.1. Putting in conference bags the promotional materials of the sponsor

We would also be happy to discuss with you a tailored package if you have any special needs. Let's talk!

Contact Us

If you are interested in sponsoring DSMIE-2018, please contact us. In your request please indicate:

- the sponsorship level you are interested in;
- an overview of what you wish to promote at the conference (e.g. tool, service, product, book etc.).

We look forward to your generous support to make DSMIE-2018 a great success!

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DSMIE-2018 **Facebook**